

DATA SHEET

SKY65249-11: WLAN 802.11b, g, n Intera™ Front-End Module

Features

- 2.4 to 2.5 GHz operation
- Cardbus, mini PC1, PCle and AP applications
- P_{OUT} @ 2.5% EVM (OFDM54): 18 dBm
- Gain: 25 dB
- Integrated PA, filters, directional detector and diversity switch
- Single supply voltage: 3.0 to 3.6 V
- Dual antennas
- Small, ultra thin package 4 x 4 x 0.9 mm
- Lead (Pb)-free and RoHS-compliant

Description

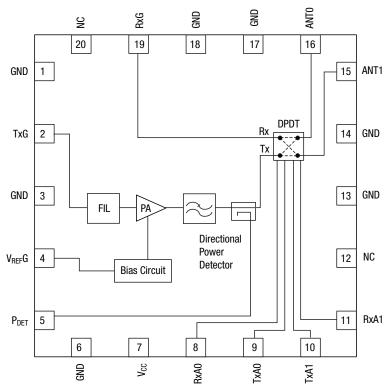
The SKY65249-11 Intera FEM contains one complete 2.4 GHz transmit/receive chain in a compact RF front-end module optimized for single band 2.4–2.5 GHz operation. The SKY65249-11 includes a PA with integrated input filtering for 3.2–3.3 GHz rejection, and temperature-compensated directional power detector with 20 dB dynamic range. Also included are low loss, high rejection harmonic filters and a diversity switch which provide high linearity in transmit and low loss in receive paths.

The SKY65249-11 is packaged in a lead (Pb)-free, RoHS-compliant laminate package, which measures 16 mm².



Skyworks offers lead (Pb)-free, RoHS (Restriction of Hazardous Substances)-compliant packaging.

Functional Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC}	V _{CC}		-0.3		5.5	V
V _{REF} G	V _{REF} G		-0.3		5.5	V
Tx In	Tx IN				10	dBm
Junction temperature	TJ				150	°C
Dissipated power	P _D			0.6	1.0	W
Thermal resistence	Θ _{JC}				55	°C/W
Moisture sensitivity level	MSL-3				250	°C
Operating temperature range	T _{OP}		-20		85	°C
Storage temperature range	T _{STO}		-65		150	°C

Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

Recommended Operating Conditions

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply voltage	V _{CC}		3	3.3	3.6	V
Reference voltage	V _{REF} G		2.8	2.9	3.0	V
Operating temperature	T _{OP}		0	25	85	°C

DC Characteristics

Conditions: V_{CC} = 3.3 V, T_{OP} = 25 °C. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Total 802.11g Tx supply current	I _{CC} -g	$P_{OUT} = 18 \text{ dBm}, 54 \text{ Mbps OFDM},$ $V_{REF}G = 2.9 \text{ V}$		180		mA
Total 802.11g Tx quiescent current	I _{CQ} -g	No RF		95		mA
Total 802.11b Tx supply current	I _{CC} -b	$P_{OUT} = 20 \text{ dBm}, 11 \text{ Mbps CCK}$ $V_{REF}G = 2.9 \text{ V}$		210		mA

PA Logic Characteristics

Conditions: $V_{CC}=3.3$ V, $T_{OP}=25$ °C. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Reference voltage high	V _{REF} G–H		2.8	2.9	3.0	V
Reference voltage low	V _{REF} G–L		0		0.3	V
Reference current high	I _{REF} G–H			4		mA
Reference current low	I _{REF} G-L			20		μΑ

Switch Characteristics

Conditions: V_{CC} = 3.3 V, T_{OP} = 25 °C. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Control voltage - ON state	V _{CTL} on		3	3.3	3.6	V
Control voltage - OFF state	V _{CTL} _off		0		0.2	V
Control current - ON state	I _{CTL} on	RF ON		10	75	uA
Control current - ON state	I _{CTL} on	RF OFF		2	20	uA

Truth Table

MODE	RxA0 (V)	RxA1 (V)	TxA0 (V)	TxA1 (V)	V _{CC} (V)	V _{REF} G (V)
Rx-ANT0	3.3	0	0	0	3.3	0
Rx-ANT1	0	3.3	0	0	3.3	0
Tx-ANT0	0	0	3.3	0	3.3	2.9
Tx-ANT1	0	0	0	3.3	3.3	2.9
TxRx-ANT0	3.3	0	3.3	0	3.3	2.9

All other conditions not recommended.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be employed at all times.

802.11b,g Transmit Specifications

Conditions: $V_{CC}=3.3$ V, $V_{REF}G=2.9$ V, $T_{OP}=25$ °C. PA enables and control voltages set according to Truth Table. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Frequency range	F		2.4		2.5	GHz
Linear output power - g	Plin_g	54 Mbps OFDM, 64 QAM, EVM = 2.5 %		18		dBm
Compliant output power - b	P _{OUT} _b	11 Mbps CCK		21		dBm
Backed off EVM	BEVM	54 Mbps OFDM, 64 QAM, P _{OUT} = 8 dBm		1.5		%
1 dB compression point	P _{1 dB}		22.5	25		dBm
Small signal gain	IS ₂₁ I			25		dB
Small signal gain variation over frequency band	Δ IS ₂₁ I			2		dB
Gain, 3.2-3.3 GHz	IS ₂₁ I - 3.2			0		dB
Harmonics	2f, 3f	P _{OUT} = 18 dBm, 1 Mbps, CCK, 802.11b		-50	-42	dBm/MHz
Tx switching time	t_sw	50 % of V _{CTL} to 90/10 % RF output			500	ns
Input return loss	IS ₁₁ I	Tx In		-10		dB
Output return loss	IS ₂₂ I	Ant A or Ant B		-8		dB
Stability	STAB	$P_{OUT} \le 18$ dBm, load VSWR = 3:1	All non-harmonically related outputs less than -50 dBc/1 MHz		utputs	

802.11b,g Receive Specifications

Conditions: $V_{CC}=3.3$ V, $V_{REF}G=2.9$ V, $T_{OP}=25$ °C. PA enables and control voltages set according to Truth Table. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Frequency range	F		2.4		2.5	GHz
Insertion loss	IS ₂₁ I			1.1	1.6	dB
Input/output return loss	IS ₁₁ I, IS ₂₂ I	RxG, Ant 0, 1		-15		dB
Antenna to Rx isolation		PA off, switch in Tx-Ant0 (Ant1) mode		23		dB
Antenna to antenna isolation		Isolation between AntO and Ant1 parts Switch in any mode		19		dB

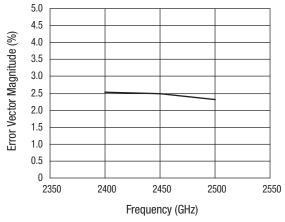
802.11b,g Power Detector Specification

Conditions: $V_{CC}=3.3~V$, $V_{REF}G=2.9~V$, $T_{OP}=25~^{\circ}C$. PA enables and control voltages set according to Truth Table. Measurements made on Skyworks EVB with all losses de-embedded. All unused ports terminated into 50 Ω unless otherwise specified.

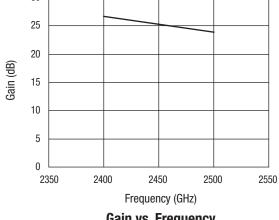
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Power detect range	PDR	Ant 0 or Ant 1	5		22	dBm
Power detector accuracy	PDacc2	Over 3:1 VSWR		±1		dB
P _{DET} load impedance				27		kΩ
P _{DET} output impedance					6	kΩ
Voltage limits		Over power range	0.1		1.1	V
Voltage range			0.3	0.6		V
Power detector -3 dB corner frequency	LPF-3 dB	10 kΩ load	270	300	400	kHz

Typical Performance Data (2.4–2.5 GHz)

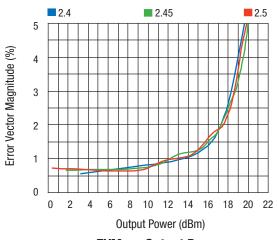
V_{CC} = 3.3 V, T_A = 25 °C, OFDM 54 Mbps, Z_0 = 50 Ω , unless otherwise noted



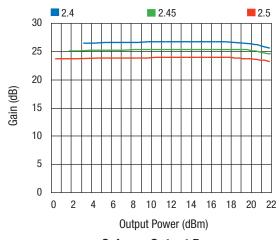
EVM vs. Frequency



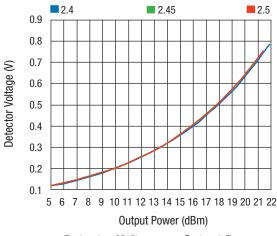
Gain vs. Frequency



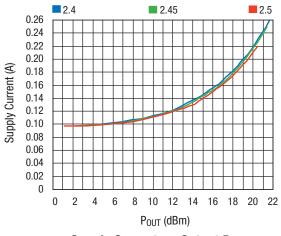
EVM vs. Output Power



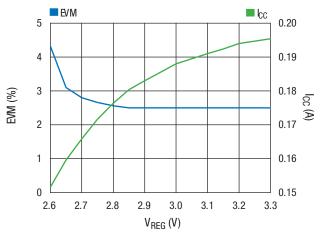
Gain vs. Output Power



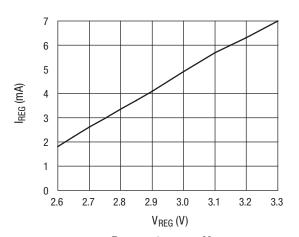
Detector Voltage vs. Output Power



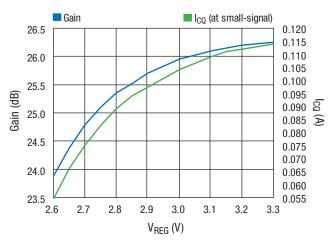
Supply Current vs. Output Power



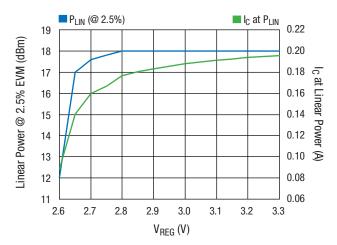
Parameters @ 18 dBm vs. V_{REG}



Parameters vs. V_{REG}

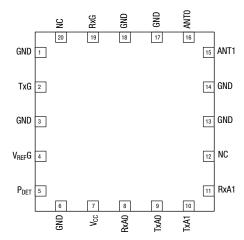


Gain vs. V_{REG}

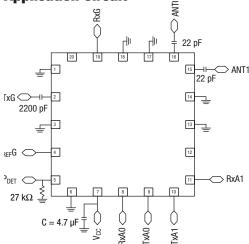


Parameters vs. V_{REG}

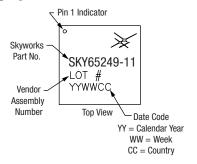
Pin Out



Application Circuit



Branding Specifications



Pin Descriptions

Pin Number	Symbol	Description
1	GND	Ground
2	TxG	Transmit input port. Internally matched
		to 50 Ω . External DC block required
		(2200 pF recommended)
3	GND	Ground
4	V _{REF} G	External reference voltage for the PA
5	P _{DET}	Directional power detector output
6	GND	Ground
7	V _{CC}	Power supply 3.3 V
8	RxA0	Digital control input DPDT
9	TxA0	Digital control input DPDT
10	TxA1	Digital control input DPDT
11	RxA1	Digital control input DPDT
12	NC	Not connected to anything externally
13	GND	Ground
14	GND	Ground
15	Ant1	Auxiliary antenna port. Internally matched to 50 Ω . External DC block required (22 pF recommended)
16	Ant0	Main antenna port. Internally matched to 50 Ω . External DC block required (22 pF recommended)
17	GND	Ground
18	GND	Ground
19	RxG	Receive output port. Internally matched to 50 Ω and DC blocked. No external DC block required
20	NC	Not connected to anything externally

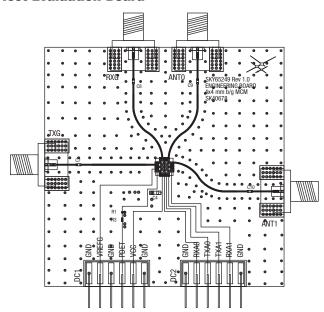
Recommended Solder Reflow Profiles

Refer to the "<u>Recommended Solder Reflow Profile</u>" Application Note.

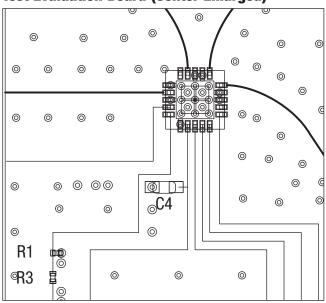
Tape and Reel Information

Refer to the "<u>Discrete Devices and IC Switch/Attenuators</u> Tape and Reel Package Orientation" Application Note.

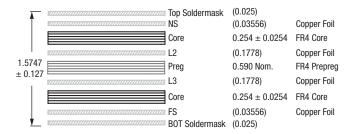
Test Evaluation Board



Test Evaluation Board (Center Enlarged)



Layer Stackup



Dimensions in mm.

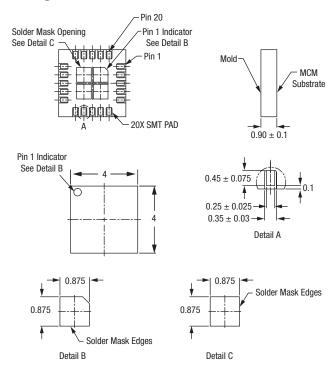
Design Information

RF line width	19.3 (0.49)	mils (mm)
DC line width	11.3 (0.29)	mils (mm)
Dielectric constant	4.2	

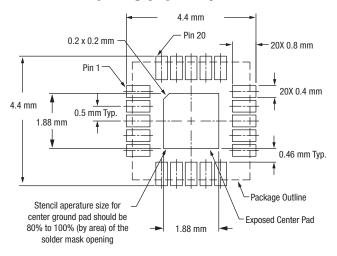
SMT BOM

Ref Des	Qty.	Description	Value	Tolerance	Size
C4	1	Capacitor	4.7 μF	± 5%	SMT 0603
C7	1	Capacitor	2200 pF	± 5%	SMT 0402
C8	1	Resistor	0 Ω	± 5%	SMT 0402
C9	1	Capacitor	22 pF	± 5%	SMT 0402
C10	1	Capacitor	22 pF	± 5%	SMT 0402
R1	1	Resistor	27 kΩ	± 5%	SMT 0201
R3	1	Resistor	0 Ω	± 5%	SMT 0201

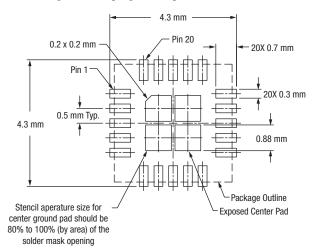
Package Dimensions



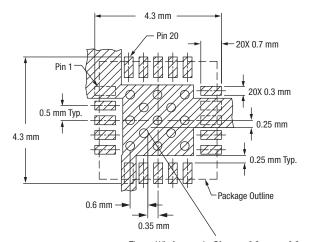
Solder Mask Opening (Top View)



Stencil Aperture (Top View)



Footprint (Top View)



Thermal Via Array under PA areas. 0.3 mm on 0.6 mm pitch. Additional vias will improve thermal performance. Note: Thermal vias should be tented and filled with solder mask. 30–35 µm Cu plating is recommended.

Copyright $\ @$ 2006, 2007, Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale.

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks, the Skyworks symbol, and "Breakthrough Simplicity" are trademarks or registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.